

LCD MODULE SPECIFICATION

Model: CG1212A - _ _ - _ - _ -

Revision	00
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Date	11 Oct 2011
Our Reference	9045

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MODE OF DISPLAY

Display mode **Display condition Viewing direction** STN: Yellow green Reflective type 6 O' clock Grey Transflective type ☐ 12 O' clock Blue (negative) Transmissive type 3 O' clock FSTN positive Others 9 O' clock FSTN negative LCD MODULE NUMBER NOTATION: <u>CG1212A- N N - S R - N 6 - T</u> *(1)---Model number of standard LCD Modules *(2)---Backlight type (1) (2) (3) (4) (5) (6) (7) (8) N – No backlight E – EL backlight L – Side-lited LED backlight M- Array LED backlight C - CCFL*(3)---Backlight color N – No backlight A - AmberB - BlueO- Orange W-White Y – Yellow green M - RGB*(4)---Display mode T - TNV – TN (Negative) S – STN Yellow green G – STN Grey B – STN Blue (Negative) F-FSTN N – FSTN (Negative) *(5)---Rear polarizer type R – Reflective F-TransflectiveT-Transmissive*(6)---Temperature range N - NormalW- Extended *(7)---Viewing direction 6 – 6 O'clock 2 – 12 O'clock 3 - 3 O'clock 9 – 9 O'clock *(8)---Special code for other requirements

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(Can be omitted if not used)

GENERAL DESCRIPTION

Display mode : 12 X 12 dots, COG LCD module

Interface : 8-bit parallel

Driving method : static

Controller IC : ST7045 or equivalent

For the detailed information, please refer to the IC specifications.

MECHANICAL DIMENSIONS

Item	Dimension		Unit	Item	Dimension		Unit
Outline Dimension	56.0(L)x65.2(W)x (H1/H2)		mm	Dot Pitch	3.96(L)x3.96(W)		mm
Viewing Area	52.0(L)x52.0(W)		mm	Dot Size	3.46(L)x3.4	6(W)	mm
No Paghlight (N)	H1	-	mm	Side Backlight	H1	8.7MAX	mm
No Backlight (N)	H2	-	mm	RGB (LM)	H2	=	mm
EL Backlight (E)	Poolslight (E) H1 - mm Amou Poolslight (M	Array Backlight (M)	H1	-	mm		
EL Dacklight (E)	H2	-	mm	Array Dacklight (WI)	H2	-	mm

CONNECTOR PIN ASSIGNMENT(CN1)

Pin No.	Symbol	Function	Pin No.	Symbol	Function
1	GND	Ground	14	D1	Data bus line
2	VLCD	Operating voltage for LCD	15	D0	Data bus fille
3	CAP1P	X2 voltage stepup	16	A0	Register select input pin
4	CAP1N	A2 voltage stepup	17	/RD	Data read control pin
5	V0	Input voltage for LCD	18	/WR	Data write control pin
6	VSS	Ground	19	/CS	Chip select input pin
7	VDD	Supply voltage for logic	20	/RST	Reset input pin
8	D7		21	LEDB	
9	D6		22	LEDG	RGB LED pulse signal output
10	D5	Data bus line	23	LEDR	
11	D4	Data dus fille	24	VSS	Ground
12	D3		25	GND	Ground
13	D2				

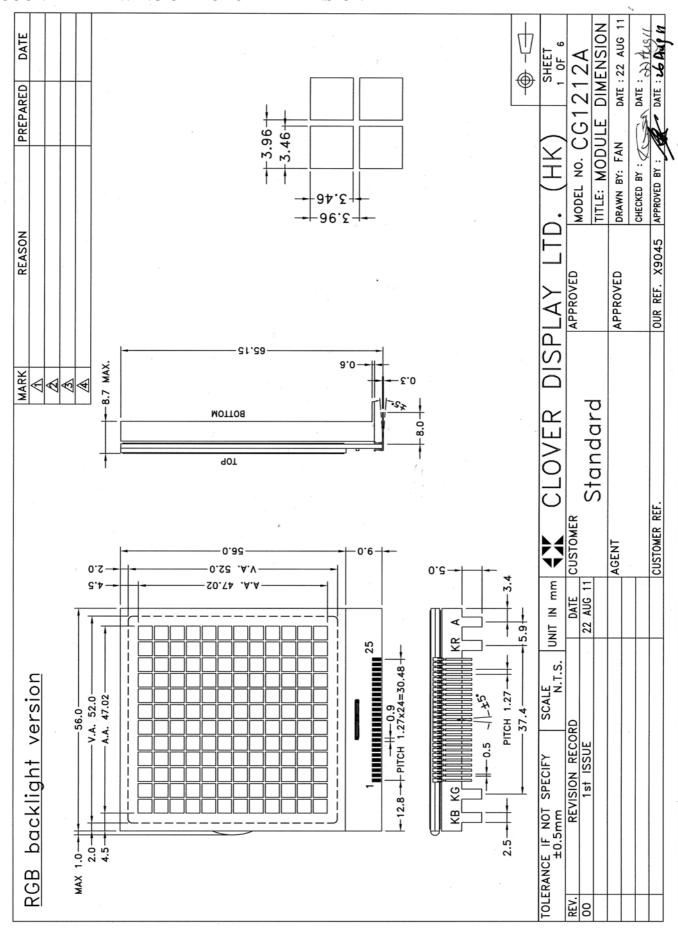
CONNECTOR PIN ASSIGNMENT OF BACKLIGHT (CN2)

Pin No.	Symbol	Function	Pin No.	Symbol	Function
(*)26	A	Supply Voltage for Backlight (+VE)	(*)28	KG	Supply Voltage for Backlight (-VE)
(*)27	KR	Supply Voltage for Backlight (-VE)	(*)29	KB	Supply Voltage for Backlight (-VE)

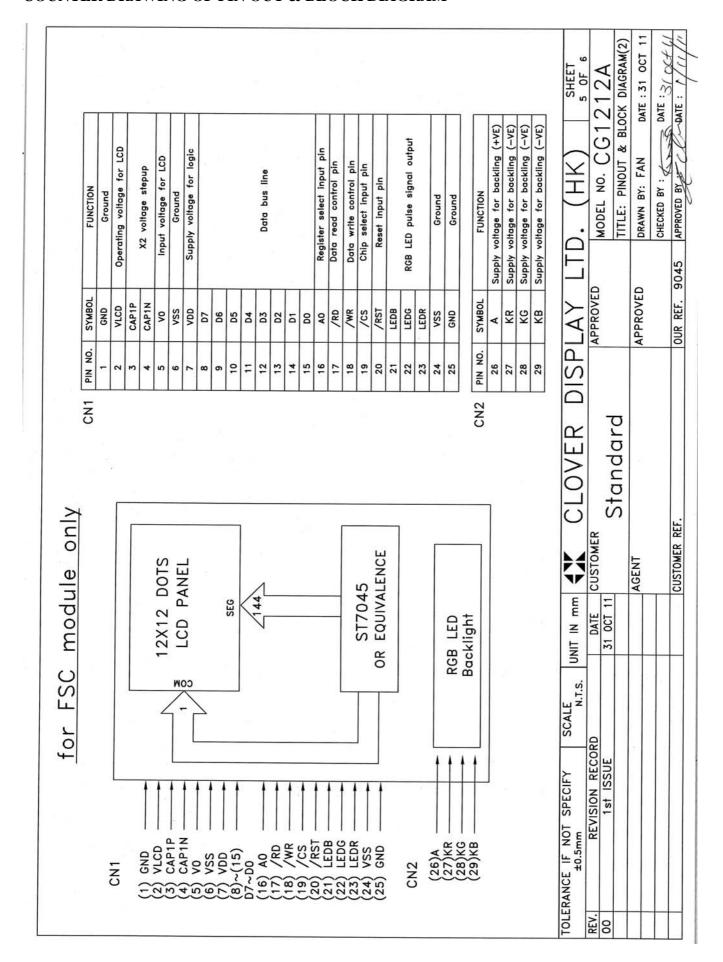
Note $(\sp{*})$: KR , KG , KB are used for RGB backlight version only

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COUNTER DRAWING OF MODULE DIMENSION



COUNTER DRAWING OF PIN OUT & BLOCK DIAGRAM



ELECTRICAL CHARACTERISTICS

ELECTRICAL CHARACTERI	Conditions: VSS=0V, Ta=25°C				
Item	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage for Logic	VDD	_	3.0	_	V
Supply Current for Logic	IDD	_	0.88	1.32	mA
Operating Voltage for LCD (*)	VLCD	_	5.0	_	V
'High' Level Input Voltage	VIH	0.7VDD	_	VDD	V
'Low' Level Input Voltage	VIL	VSS	_	0.2VDD	V

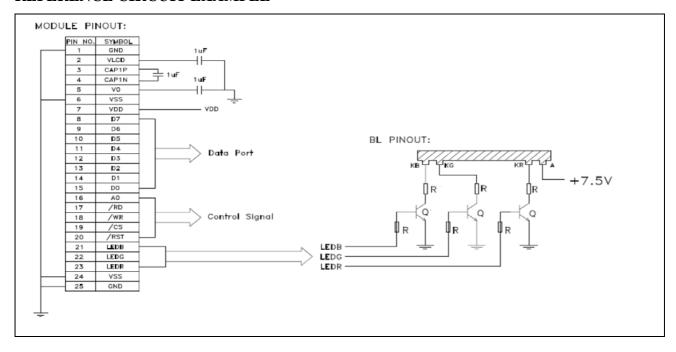
Note (*): There is tolerance in optimum LCD driving voltage during production and it will be within the specified range.

Side Backlight for RGB (LM):

Constant current driving:

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Red BL Voltage	V_R	1.8	2.0	2.2	V	$I_R = 80 \text{mA}$
Green BL Voltage	V_{G}	2.9	3.15	3.3	V	$I_G = 40 \text{mA}$
Blue BL Voltage	V_{B}	2.7	3.1	3.2	V	$I_B = 20 \text{mA}$

REFERENCE CIRCUIT EXAMPLE



ABSOLUTE MAXIMUM RATINGS

Please make sure not to exceed the following maximum rating values under the worst application conditions

Item	Symbol	Rating (for normal temperature)	Unit
Supply Voltage	Vdd	-0.3to 3.6	V
Input Voltage	VT	-0.3 to VDD +0.5	V
Operating Temperature	Topr	0 to 50	${\mathbb C}$
Storage Temperature	Tstg	-10 to 60	${\mathbb C}$

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INSTRUCTIONS TABLE

COMMAND					CO	DE					DESCRIPTION	
COMMAND	HEX	A0	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION	
NOP	00	0	0	0	0	0	0	0	0	0	No Operation	
Software reset	01	0	0	0	0	0	0	0	0	1	Software reset	
Sleep in	10	0	0	0	0	1	0	0	0	0	Sleep in mode	
Sleep out	11	0	0	0	0	1	0	0	0	1	Sleep out mode	
Inverse display off	20	0	0	0	1	0	0	0	0	0	Display Inversion off	
Inverse display on	21	0	0	0	1	0	0	0	0	1	Display Inversion on	
Exit all point on	22	0	0	0	1	0	0	0	1	0	Exit all point on	
Enter all point on	23	0	0	0	1	0	0	0	1	1	Enter all point on	
Display off	28	0	0	0	1	0	1	0	0	0	Display off	
Display on	29	0	0	0	1	0	1	0	0	1	Display on	
	2A	0	0	0	1	0	1	0	1	0	Column address set	
Column address set	-	1	CS7	CS6	CS5	CS4	CS3	CS2	CS1	CS0	Column start address	
	-	1	CE7	CE6	CE5	CE4	CE3	CE2	CE1	CE0	Column end address	
Memory write	2C	0	0	0	1	0	1	1	0	0	Write data to memory	
Memory read	2E	0	0	0	1	0	1	1	1	0	Read data from memory	
•	B1	0	1	0	1	1	0	0	0	1	. =	
LED Mode	-	1	0	0	0	0	0	0	LEDP	0	LED Mode	
	B2	0	1	0	1	1	0	0	1	0		
Frame Frequency	-	1	0	0	0	1	FR3	FR2	FR1	FR0	Frame Frequency	
	B4	0	1	0	1	1	0	1	0	0		
	-	1	SRR3	SRR2	SRR1	SRR0	SRF3	SRF2	SRF1	SRF0		
SEG waveform set	-	1	SGR3	SGR2	SGR1	SGR0	SGF3	SGF2	SGF1	SGF0	SEG waveform set	
	-	1	SBR3		SBR1	SBR0	SBF3	SBF2	SBF1	SBF0		
	В6	0	1	0	1	1	0	1	1	0		
	-	1	LRS7	LRS6	LRS5	LRS4	LRS3	LRS2	LRS1	LRS0	•	
	-	1	LGS7	LGS6	LGS5	LGS4	LGS3	LGS2	LGS1	LGS0		
LED waveform set	-	1	LBS7	LBS6	LBS5	LBS4	LBS3	LBS2	LBS1	LBS0	LED waveform set	
	-	1	LRW7	LRW6	LRW5	LRW4	LRW3	LRW2	LRW1	LRW0		
	-	1					LGW3					
	-	1	LBW7	LBW6	LBW5	LBW4	LBW3	LBW2	LBW1	LBW0		
I OD a constant	В7	0	1	0	1	1	0	1	1	1	LCD scan set	
LCD scan set	-	1	0	MX	0	0	MS	0	0	0	Master/Slave enable	
Enter Read modify	B8	0	1	0	1	1	1	0	0	0	Enter Read modify	
Exit Read modify	В9	0	1	0	1	1	1	0	0	1	Exit Read modify	
•	C0	0	1	1	0	0	0	0	0	0	•	
Vop set	-	1	Vop7	Vop6	Vop5	Vop4	Vop3	Vop2	Vop1	Vop0	Vop set	
•	-	1	0	0	0	0	0	0	0	Vop8	Range 3V to 18V	
D 0 : :	D2	0	1	1	0	1	0	0	1	0	5 0 1 1	
Power Control	-	1	0	0	0	OSC	BST	FOL	VO	VREF	Power Control	
000150	D4	0	1	1	0	1	0	1	0	0	DOD I ED	
RGB LED control	-	1	0	0	0	0	BK	LEDR	LEDG		RGB LED control	

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RECOMMENDED INITIAL SETTINGS

System Reset: 01H Sleep out: 11H

Power control: d2H,00H Vop Set: c0H,32H,00H LED mode: b1H,02H LCD scan set: b7H,00H

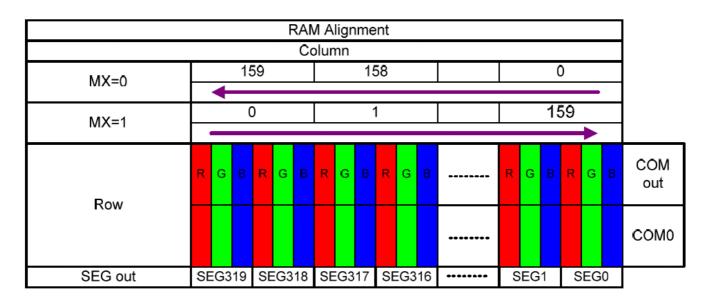
Seg waveform set: b4H,22H,22H,22H

Led waveform set: b6H,22H,22H,22H,33H,33H,33H

Display on: 29H

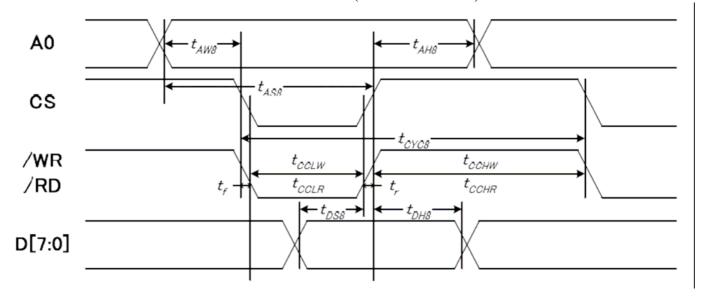
DISPLAY DATA RAM

It is 320 X 1 X 3 bits capacity RAM prepared for storing dot data. Refer to the following memory map for the RAM Configuration.



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PARALLEL INTERFACE TIMING DIAGRAM (For 8080-series)



PARALLEL INTERFACE TIMING CHARACTERISTICS((For 8080-series)

(VSS=0V, VDDI=2.4~3.3V, VDDA=3.0V, Ta = 25℃)

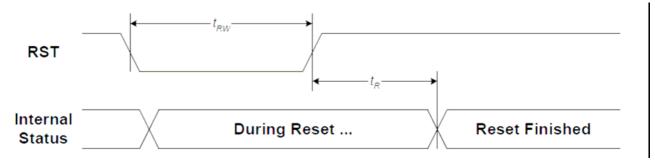
Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time		tAW8		T.B.D	_	
Address setup time	A0	tAS8		T.B.D	_	
Address hold time		tAH8		T.B.D	_	
System cycle time		tCYC8		T.B.D	_	
/WR L pulse width (WRITE)	WR	tCCLW		T.B.D	_	
/WR H pulse width (WRITE)		tCCHW		T.B.D	_	ns
/RD L pulse width (READ)	DD.	tCCLR		T.B.D	_	
/RD H pulse width (READ)	RD	tCCHR		T.B.D	_	
WRITE Data setup time	D(7:01	tDS8		T.B.D	_	
WRITE Data hold time	D[7:0]	tDH8		T.B.D	_	

^{*1} The input signal rise and fall time (tr, tf) are specified at 15 ns or less.

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^{*2} All timing is specified using 20% and 80% of VDDI as the standard.

RESET TIMING DIAGRAM



RESET TIMING

(VSS=0V, VDDI=2.4~3.3V, VDDA=3.0V, Ta = 25℃)

Item	Symbol	Condition	Min.	Max.	Unit
Reset time	tR		_	T.B.D	
Reset "L" pulse width	tRW		T.B.D	_	us

^{*1} The input signal rise and fall time (tr, tf) are specified at 15 ns or less.

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^{*2} All timing is specified using 20% and 80% of VDDI as the standard.

THE RESET CIRCUIT

Setting /RST to"L" or Reset instruction can initialize internal function.

When /RST becomes "L", following procedure is occurred.

- -- Oscillator circuit is stopped
- -- The LCD power supply circuit is stopped
- -- Display OFF
- -- Display all point OFF
- -- Segment/Common output go to the VSS level

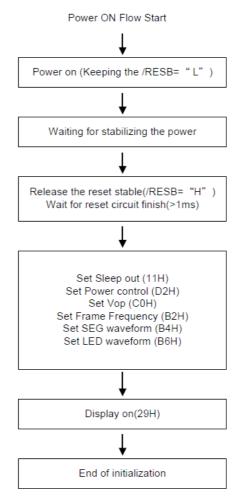
Display normal Row address: 0 Column address: 0

Power control [OSC BST FOL V0 VREF] = All OFF

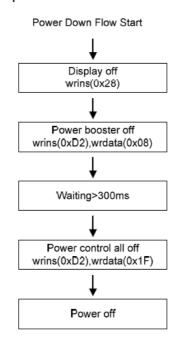
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INITIALIZING WITHOUT THE BUILT-IN POWER SUPPLY CIRCUITS

Referential instruction setup flow for power on:



Referential instruction setup flow for power down:



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ELECTRO-OPTICAL CHARACTERISTICS

MEASURING CONDITION: POWER SUPPLY = VOP / 64 HzTEMPERATURE = 23 ± 5 °C

RELATIVE HUMIDITY = $60 \pm 20 \%$

ITEM	SYMBOL	UNIT	TYP. TN
RESPONSE TIME	Ton	ms	60
	Toff	ms	80
CONTRAST RATIO	Cr	-	30
	V3:00	0	70
VIEWING ANGLE	V6:00	0	65
(Cr ≥ 2)	V9:00	0	70
	V12:00	0	25

THE ELECTRO-OPTICAL CHARACTERISTICS ARE MEASURED VALUE BUT NOT GUARANTEED ONES.

RELIABILITY OF LCD MODULE

	TEST CONDITION	
ITEM	FOR NORMAL TEMPERATURE	TIME
High temperature operating	50°C	240 hours
Low temperature operating	0°C	240 hours
High temperature storage	60°C	240 hours
Low temperature storage	-10°C	240 hours
Temperature-humidity storage	40°C 90% R.H.	96 hours
Temperature cycling	-10°C to 60°C	5 avala
	30 Min Dwell	5 cycle
Vibration Test at LCM Level	Freq 10-55 Hz	
	Sweep rate: 10-55-10 at 1 min	
	Sweep mode Linear	_
	Displacement: 2 mm p-p	
	1 Hour each for X, Y, Z	

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SAMPLING METHOD

SAMPLING PLAN: MIL-STD 105E

CLASS OF AQL: LEVEL II/ SINGLE SAMPLING

 $MAJOR-0.65\% \qquad MINOR-1.5\%$

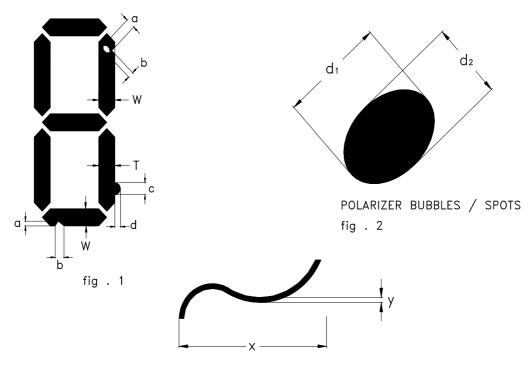
QUALITY STANDARD

DEFECT	CRITERIA		ТҮРЕ	FIGURE
SHORT CIRCUIT	-		MAJOR	-
MISSING SEGMENT	-		MAJOR	-
UNEVEN / POOR CONTRAST	-		MAJOR	-
CROSS TALK	-		MAJOR	-
PIN HOLE	$MAX(a,b) \le 1/4 W$		MINOR	1
EXCESS SEGMENT	$MAX(c,d) \leq 1/4T$		MINOR	1
BUBBLES	d* ≥ 0.2	QTY=0	MINOR	2
BLACKS SPOTS	d ≤ 0.3	N.A.**	MINOR	2
	0.3 <d≤0.4< td=""><td>QTY≤1</td><td></td><td></td></d≤0.4<>	QTY≤1		
	0.4 <d< td=""><td>QTY=0</td><td></td><td></td></d<>	QTY=0		
LINE SCRATCHES	x≥0.7 y≥0.05	QTY=0	MINOR	3
BLACK LINE	x≥0.7 y≥0.05	QTY=0	MINOR	3

* $d = MAX(d_1,d_2)$

** N. A . = NOT APPLICABLE

DEFECT TABLE : B



LINE SCRATCHES / BLACK LINE fig . 3

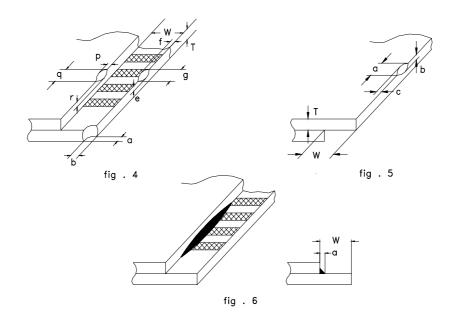
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$\ \, \textbf{QUALITY STANDARD} \, (\, \, \textbf{CONT.})$

DEFECT		CRITERIA	ТҮРЕ	FIGURE
	CONTACT EDGE	e≤1/2T f≤1/3W g≤3.5		4
CHIPS	BOTTOM GLASS	p≤1.0 q≤3.5 r≤1/2T	MINOR	4
	CORNER	a≤1.5 b≤W		4
	TOP GLASS	a≤3.0 b≤1/3T c≤1/2W		5
GLASS PROTRUSION		$a \le 1/4 \text{ W}$	MINOR	6
RAINBOW	•	-	MINOR	-

UNLESS STATE OTHERWISE , ALL UNIT ARE IN MILLIMETER .

DEFECT TABLE : B



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HANDLING PRECAUTIONS

(1) CAUTION OF LCD HANDLING & CLEANING

Use soft cloth with solvent (recommended below) to clean the display surface and wipe lightly.

- Isopropyl alcohol, ethyl alcohol, trichlorotriflorothane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent;

-water, ketone, aromatics

(2) CAUTION AGAINST STATIC CHARGE

The LCD modules use CMOS LSI drivers, so customers are recommend that any unused input terminal would be connected to V_{DD} or V_{SS} , do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

Remove the protective film slowly and, if possible, under ESD control device like ion blower and humidity of working room should be kept over 50%RH to reduce risk of static charge.

(3) PACKAGING

Avoid intense shock and falls from a height and do not operate or store them exposed direct to sunshine or high temperature/humidity.

(4) CAUTION FOR OPERATION

It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage than the limit causes the shorter LCD life. The use of direct current drive should be avoided because an electrochemical reaction due to direct current causes LCD's undesirable deterioration.

Response time will be extremely delayed at low temperature, and LCD's show dark color at high temperature. However those phenomena do not mean malfunction or out of order with LCD's.

Some font will be abnormally displayed when the display area is pushed hard during operation. But it resumes normal condition after turning off once.

(5) SOLDERING (for Pin type)

It is recommended to complete dip soldering at 270 °C or hand soldering at 280 °C within 3 seconds. The soldering position is at least 3mm apart from the pin head. Wave or reflow soldering are not recommended. Metal pins should not be soldered for more than 3 times and each soldering should be done after cool down of metal pins

(6) SAFETY

For crash damaged or unnecessary LCD's, it is recommended to wash off liquid crystal by either of solvents such as acetone and ethanol and should be burned up later.

When any liquid leaked out of a damaged glass cell comes in contact with your hands, wash it off with soap and water.

WARRANTY

CLOVER will replace or repair any of her LCD module in accordance with her LCD specification for a period of one year from date of shipment. The warranty liability of Clover is limited to repair and/or replacement. Clover will not be responsible for any subsequent or consequential event.

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